**NICHIA CORPORATION** 

**SPECIFICATIONS FOR WHITE LED** 

# **NC2W321BT**

- ESD Withstand Voltage (HBM) Class 3B
- RoHS Compliant
- IATF 16949 Compliant





## **SPECIFICATIONS**

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	${ m I}_{\sf F}$	1200	mA
Pulse Forward Current	$\mathbf{I}_{FP}$	1500	mA
ESD Withstand Voltage (HBM)	$V_{ESD}$	8	kV
Allowable Reverse Current	${ m I}_{ m R}$	85	mA
Power Dissipation	$P_{D}$	8.4	W
Operating Temperature	$T_{opr}$	-40~125	°C
Storage Temperature	$T_{stg}$	-40~125	°C
Junction Temperature	T <sub>3</sub>	150	°C

<sup>\*</sup> Absolute Maximum Ratings at  $T_C=25^{\circ}C$ .

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Тур	Max	Unit
Forward Voltage		$V_{F}$	I <sub>F</sub> =1000mA	6.5	-	٧
Luminous Flux		Ф	I <sub>F</sub> =1000mA	730	-	lm
	х		I <sub>F</sub> =1000mA	0.327	-	
Chromaticity Coordinate	у	-	I <sub>F</sub> =1000mA	0.337	-	-
Thermal Resistance		R <sub>0JC_real</sub>	-	3.2	4.0	
		R <sub>0JC el</sub>	-	2.1	2.6	°C/W

<sup>\*</sup> Characteristics at  $T_C=25$ °C.

<sup>\*</sup>  $I_{\text{FP}}$  conditions with pulse width  $\leq\!10\text{ms}$  and duty cycle  $\leq\!10\%.$ 

<sup>\*</sup> HBM ESD Component Classification Level of the LEDs: Class 3B For more details, see ANSI/ESDA/JEDEC JS-001.

<sup>\*</sup> Luminous Flux value as per CIE 127:2007 standard.

<sup>\*</sup> Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

<sup>\*</sup> Thermal resistance values ( $R_{\theta JC\_real}$ ) determined by considering the energy conversion efficiency( $\eta_e$ =33%). Refer to JESD51.

## **RANKS**

Item	Rank	Min	Max	Unit
Forward Voltage	-	5.6	7.0	V
	M800	800	850	
Luminous Flux	M750	750	800	lm
	M700	700	750	

Color Ranks

	Rank ca2b						
х	0.317	0.321	0.335	0.330			
У	0.314	0.340	0.333	0.323			

	Rank ca3b						
х	0.321	0.327	0.337	0.340	0.335		
У	0.340	0.350	0.357	0.343	0.333		

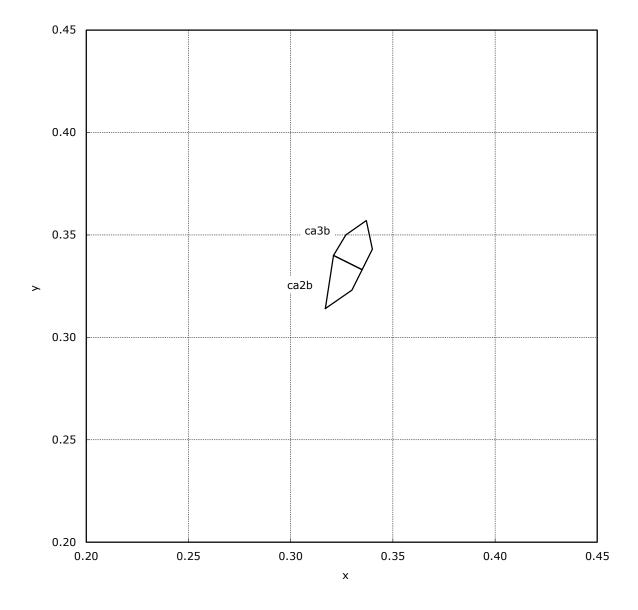
\* Ranking at  $T_C=25^{\circ}C$ .

\* Forward Voltage Tolerance:  $\pm 0.07V$ 

\* Luminous Flux Tolerance: ±5%

\* Chromaticity Coordinate Tolerance: ±0.003

st LEDs from the above ranks will be shipped. The rank combination ratio per shipment will be decided by Nichia.

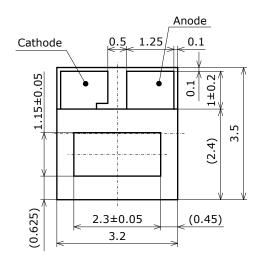


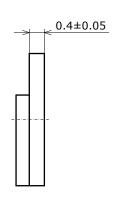
# **OUTLINE DIMENSIONS**

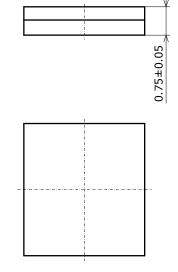
- \* 本製品はRoHS指令に適合しております。 This product complies with RoHS Directive.
- \* 括弧で囲まれた寸法は参考値です。 The dimension(s) in parentheses are for reference purposes.

NC2W321B 管理番号 No. STS-DA7-12802A

(単位 Unit: mm, 公差 Tolerance: ±0.1)

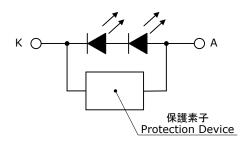




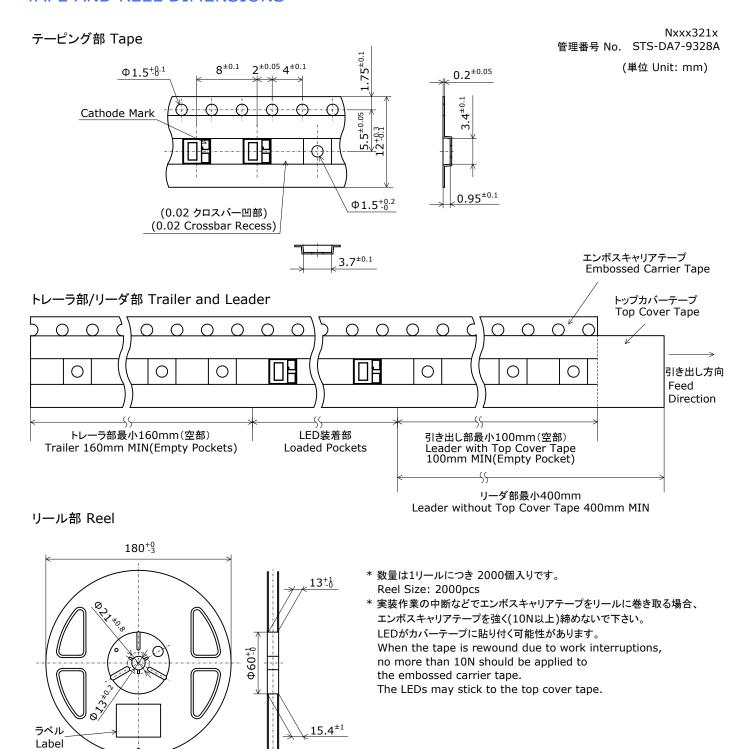


項目 Item	内容 Description
パッケージ材質 Package Materials	セラミックス Ceramics
蛍光体板材質 Phosphor sheet Materials	硬質ガラス(蛍光体入り) Hard Glass (with phosphor)
封止樹脂材質 Encapsulating Resin Materials	シリコーン樹脂 Silicone Resin
電極材質 Electrodes Materials	アルミニウム Aluminum
質量 Weight	0.020g(TYP)

\* バリは寸法に含まないものとします。 Dimensions do not include mold flash.

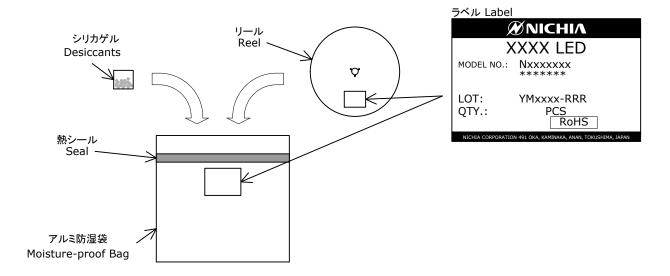


## TAPE AND REEL DIMENSIONS

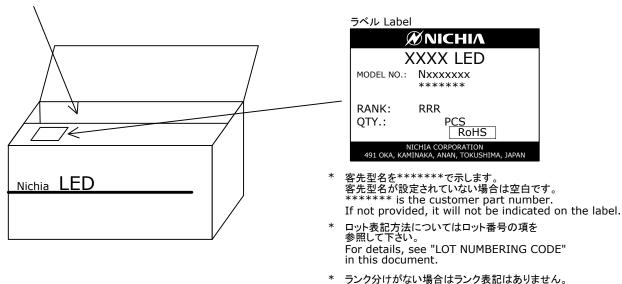


#### PACKAGING - TAPE & REEL

シリカゲルとともにリールをアルミ防湿袋に入れ、熱シールにより封をします。 Reels are shipped with desiccants in heat-sealed moisture-proof bags. Nxxxxxxx 管理番号 No. STS-DA7-0006D



アルミ防湿袋を並べて入れ、ダンボールで仕切ります。 Moisture-proof bags are packed in cardboard boxes with corrugated partitions.



- The label does not have the RANK field for un-ranked products.
- \* 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
  Products shipped on tape and reel are packed in a moisture-proof bag.
  They are shipped in cardboard boxes to protect them from external forces during transportation.
- \* 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or expose the box to external forces as it may damage the products.
- \* ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water. The box is not water-resistant.
- \* 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。 Using the original package material or equivalent in transit is recommended.

# LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2018	I
2019	J
2020	K
2021	L
2022	М
2023	N

M - Month

Total						
Month	М	Month	М			
1	1	7	7			
2	2	8	8			
3	3	9	9			
4	4	10	A			
5	5	11	В			
6	6	12	С			

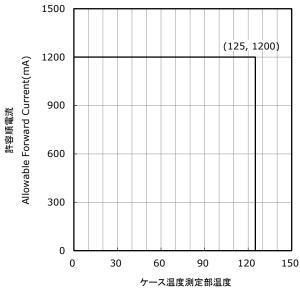
xxxx-Nichia's Product Number

RRR-Ranking by Color Coordinates, Ranking by Luminous Flux

NCxW321x 管理番号 No. STS-DA7-9001C

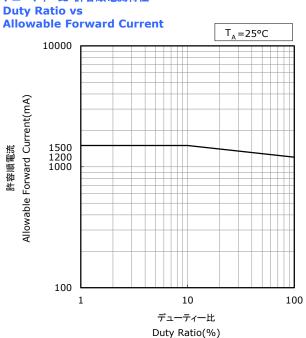
ケース温度測定部温度-許容順電流特性

# Temperature at Measurement Point on a Case vs Allowable Forward Current



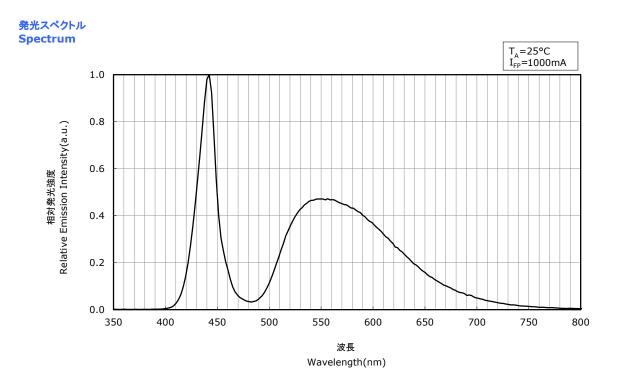
Temperature at Measurement Point on a Case(°C)

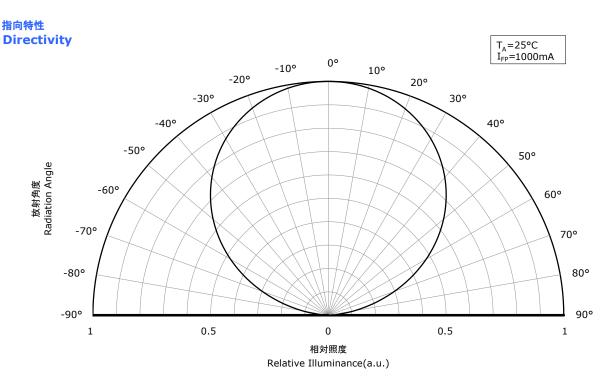
#### デューティー比-許容順電流特性



# OPTICAL CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NC2W321B 管理番号 No. STS-DA7-12794A

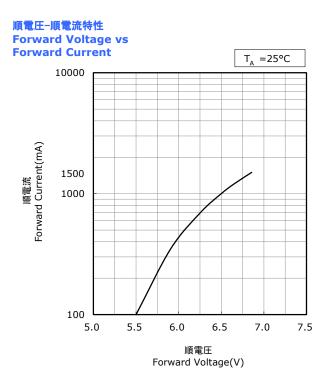


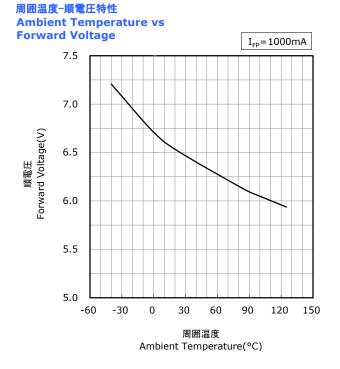


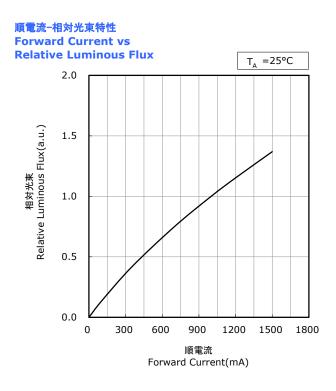
# FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

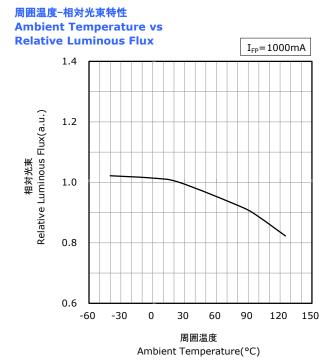
\* 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.

NC2W321B 管理番号 No. STS-DA7-12795A









# FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NC2W321B 管理番号 No. STS-DA7-12796B

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate

0.36

0.35

> 0.34

1000mA
1200mA
1500mA
0.33

0.31

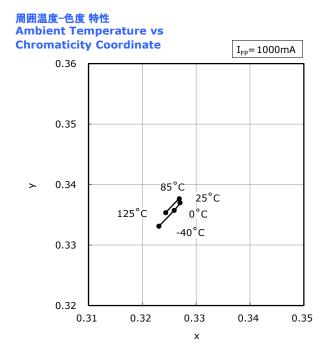
0.32

0.33

Х

0.34

0.35



## **RELIABILITY**

## (1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Thermal Shock		-40°C to 125°C, 15min dwell	100cycles	#1	0/22
Moisture Resistance (Cyclic)	JEITA ED-4701 200 203	25°C~65°C~-10°C, 90%RH, 24hr per cycle	10cycles	#1	0/10
High Temperature Storage	JEITA ED-4701 200 201	T <sub>A</sub> =125°C	1000hours	#1	0/10
Temperature Humidity Storage	JEITA ED-4701 100 103	T <sub>A</sub> =85°C, RH=85%	1000hours	#1	0/10
Low Temperature Storage	JEITA ED-4701 200 202	T <sub>A</sub> =-40°C	1000hours	#1	0/10
Room Temperature Operating Life		T <sub>A</sub> =25°C, I <sub>F</sub> =1200mA	1000hours	#1	0/10
High Temperature Operating Life		T <sub>A</sub> =125°C, I <sub>F</sub> =660mA	1000hours	#1	0/10
Temperature Humidity Operating Life		85°C, RH=85%, I <sub>F</sub> =1200mA	1000hours	#1	0/10
Low Temperature Operating Life		T <sub>A</sub> =-40°C, I <sub>F</sub> =1200mA	1000hours	#1	0/10
Electrostatic Discharges	ANSI/ESDA/ JEDEC JS-001	HBM, 8kV, $1.5k\Omega$ , $100pF$ , $1pulse$ , alternately positive or negative		#1	0/10

#### NOTES:

- 1) R<sub>θJA</sub>≈9.0°C/W
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

### (2) Failure Criteria

1							
	Criteria #	Items	Conditions	Failure Criteria			
		Forward Voltage(V <sub>F</sub> )	I <sub>F</sub> =1000mA	>U.S.L.×1.1			
	#1	Luminous Flux(Φ <sub>v</sub> )	I <sub>F</sub> =1000mA	<l.s.l.×0.7< td=""></l.s.l.×0.7<>			

U.S.L. : Upper Specification Limit L.S.L. : Lower Specification Limit

#### **CAUTIONS**

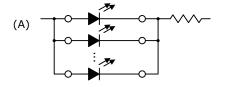
#### (1) Storage

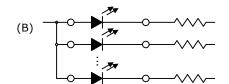
Conditions		Temperature	Humidity	Time
	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date
Storage	After Opening Aluminum Bag	≤30°C	≤70%RH	≤168hours
Baking		65±5°C	-	≥24hours

- After opening the moisture-proof aluminum bag, the products should go through the assembly process within the range of the conditions stated above. Unused remaining LEDs should be stored with silica gel desiccants in a hermetically sealed container, preferably the original moisture-proof bags for storage.
- If the "After Opening" storage time has been exceeded or any pink silica gel beads are found, ensure that the LED are baked before use. Baking should only be done once.
- Although the leads or electrode pads (anode and cathode) of the product are plated with aluminum, prolonged exposure to a corrosive environment might cause the aluminum plated the leads or electrode pads to tarnish. If unused LEDs remain, they must be stored in a hermetically sealed container. Nichia recommends using the original moisture-proof bag for storage.
- To prevent substances/gases from affecting the plated surface, ensure that the parts/materials used with the LEDs in the same assembly/system do not contain sulfur (e.g. gasket/seal, adhesive, etc.). If the plating is contaminated, it may cause issues (e.g. electric connection failures). If a gasket/seal is used, silicone rubber gaskets/seals are recommended; ensure that this use of silicone does not result in issues (e.g. electrical connection failures) caused by low molecular weight volatile siloxane.
- To avoid condensation, the LEDs must not be stored in areas where temperature and humidity fluctuate greatly.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment over a long period of time where the temperature is higher than normal room temperature.

#### (2) Directions for Use

• The circuit must be designed to ensure that the Absolute Maximum Ratings are not exceeded for each LED. The LEDs should be operated at a constant current per LED. In the case of operating at a constant voltage, Circuit B is recommended. If Circuit A is used, it may cause the currents flowing through the LEDs to vary due to the variation in the forward voltage characteristics of the LEDs on the circuit.





- This LED is designed to be operated at a forward current. Ensure that no voltage is applied to the LED in the forward/reverse direction while the LED is off. If the LEDs are used in an environment where reverse voltages are applied to the LED continuously, it may cause electrochemical migration to occur causing the LED to be damaged. When not in use for a long period of time, the system's power should be turned off to ensure that there are no issues/damage.
- To stabilize the LED characteristics while in use, Nichia recommends that the LEDs are operated at currents ≥ 10% of the sorting current.
- Ensure that transient excessive voltages (e.g. lighting surge) are not applied to the LEDs.
- If the LEDs are used for outdoor applications, ensure that necessary measures are taken (e.g. protecting the LEDs from water/salt damage and high humidity).

#### (3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the bump to break, which will cause the LED not to illuminate.
- Ensure that when handling the LEDs with tweezers, excessive force is not applied to the LED. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the internal connection to fail causing a catastrophic failure (i.e. the LED not to illuminate).
- Dropping may cause damage to the LED (e.g. deformation).
- Do not stack assembled PCBs together. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the internal connection to fail causing a catastrophic failure (i.e. the LED not to illuminate).

#### (4) Design Consideration

- PCB warpage after mounting the products onto a PCB can cause the package to break. The LED should be placed in a way to minimize the stress on the LEDs due to PCB bow and twist.
- The amount of mechanical stress exerted on the LED from depaneling may vary depending on the LED position/orientation on the PCB assembly (e.g. especially in areas near V-groove scores). The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB is separated into individual PCB assemblies.
- To separate a PCB populated with the LEDs, use a specially designed tool. Do not break the PCB by hand.
- Volatile organic compounds that have been released from materials present around the LEDs (e.g. housing, gasket/seal, adhesive, secondary lens, lens cover, etc.) may penetrate the LED lens and/or encapsulating resin. If the LEDs are being used in a hermetically sealed environment, these volatile compounds can discolor after being exposed to heat and/or photon energy and it may greatly reduce the LED light output and/or color shift. In this case, ventilating the environment may improve the reduction in light output and/or color shift. Perform a light-up test of the chosen application for optical evaluation to ensure that there are no issues, especially if the LEDs are planned to be used in a hermetically sealed environment.

#### (5) Electrostatic Discharge (ESD)

- This LED is sensitive to transient excessive voltages (e.g. ESD, lightning surge). If this excessive voltage occurs in the circuit, it may cause the LED to be damaged causing issues (e.g. the LED to become dimmer or not to illuminate [i.e. catastrophic failure]). Ensure that when handling the LEDs, necessary measures are taken to protect them from an ESD discharge. The following examples are recommended measures to eliminate the charge:
  - Grounded wrist strap, ESD footwear, clothes, and floors
  - Grounded workstation equipment and tools
  - ESD table/shelf mat made of conductive materials
- Ensure that all necessary measures are taken to prevent the LEDs from being exposed to transient excessive voltages (e.g. ESD, lightning surge):
  - tools, jigs, and machines that are used are properly grounded
  - appropriate ESD materials/equipment are used in the work area
  - the system/assembly is designed to provide ESD protection for the LEDs
- If the tool/equipment used is an insulator (e.g. glass cover, plastic, etc.), ensure that necessary measures have been taken to protect the LED from transient excessive voltages (e.g. ESD). The following examples are recommended measures to eliminate the charge:
  - Dissipating static charge with conductive materials
  - Preventing charge generation with moisture
  - Neutralizing the charge with ionizers
- To detect if an LED was damaged by transient excess voltages (i.e. an ESD event during the system's assembly process), perform a characteristics inspection (e.g. forward voltage measurement, light-up test) at low current (≤1mA).
- Failure Criteria:  $V_F$ <4.0V at  $I_F$ =0.5mA

If the LED is damaged by transient excess voltages (e.g. ESD), it will cause:

- the Forward Voltage (V<sub>F</sub>) to decrease
- the LED not to illuminate at a low current

### (6) Thermal Management

- The Absolute Maximum Junction Temperature (T<sub>1</sub>) must not be exceeded under any circumstances. The increase in the temperature of an LED while in operation may vary depending on the PCB thermal resistance and the density of LEDs on the PCB assembly. Ensure that when using the LEDs for the chosen application, heat is not concentrated in an area and properly managed in the system/assembly.
- The operating current should be determined by considering the temperature conditions surrounding the LED (i.e. T<sub>A</sub>). Ensure that when operating the LED, proper measures are taken to dissipate the heat.

#### (7) Cleaning

- Do not clean the LEDs with water, benzine and/or thinner.
- To clean the LEDs, use isopropyl alcohol (IPA). If another solvent is used, it may cause the LED package/resin to be damaged causing issues; ensure that sufficient verification is performed prior to use. Additionally, ensure that the solvent being used does not cause any other issues (e.g. CFC-based solvents are heavily regulated).
- If an LED is contaminated (e.g. dust/dirt), use a cloth soaked with isopropyl alcohol (IPA). Ensure that the cloth is firmly squeezed before wiping the LED.
- Do not clean the LEDs with an ultrasonic cleaner. If cleaning must be done, ensure that sufficient verification is performed by using a finished assembly with LEDs to determine cleaning conditions (e.g. ultrasonic power, LED position on the PCB assembly) that do not cause an issue

#### (8) Eye Safety

- There may be two important international specifications that should be noted for safe use of the LEDs: IEC 62471:2006

  Photobiological safety of lamps and lamp systems and IEC 60825-1:2001 (i.e. Edition 1.2) Safety of Laser Products Part 1:

  Equipment Classification and Requirements. Ensure that when using the LEDs, there are no issues with the following points:
  - LEDs have been removed from the scope of IEC 60825-1 since IEC 60825-1:2007 (i.e. Edition 2.0) was published. However, depending on the country/region, there are cases where the requirements of the IEC 60825-1:2001 specifications or equivalent must be adhered to.
  - LEDs have been included in the scope of IEC 62471:2006 since the release of the specification in 2006.
  - Most Nichia LEDs will be classified as the Exempt Group or Risk Group 1 according to IEC 62471:2006. However, in the case of high-power LEDs containing blue wavelengths in the emission spectrum, there are LEDs that will be classified as Risk Group 2 depending on the characteristics (e.g. radiation flux, emission spectrum, directivity, etc.)
  - If the LED is used in a manner that produces an increased output or with an optic to collimate the light from the LED, it may cause damage to the human eye.
- If an LED is operated in a manner that emits a flashing light, it may cause health issues (e.g. visual stimuli causing eye discomfort).

  The system should be designed to ensure that there are no harmful effects on the human body.

#### (9) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria as detailed in the Reliability section within this specification; it is the customer's responsibility to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required for the intended use are met.
- The applicable warranty period is one year from the date that the LED is delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia's discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- This LED is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices) and automobiles; it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LED is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LED.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).